

FIG. 1

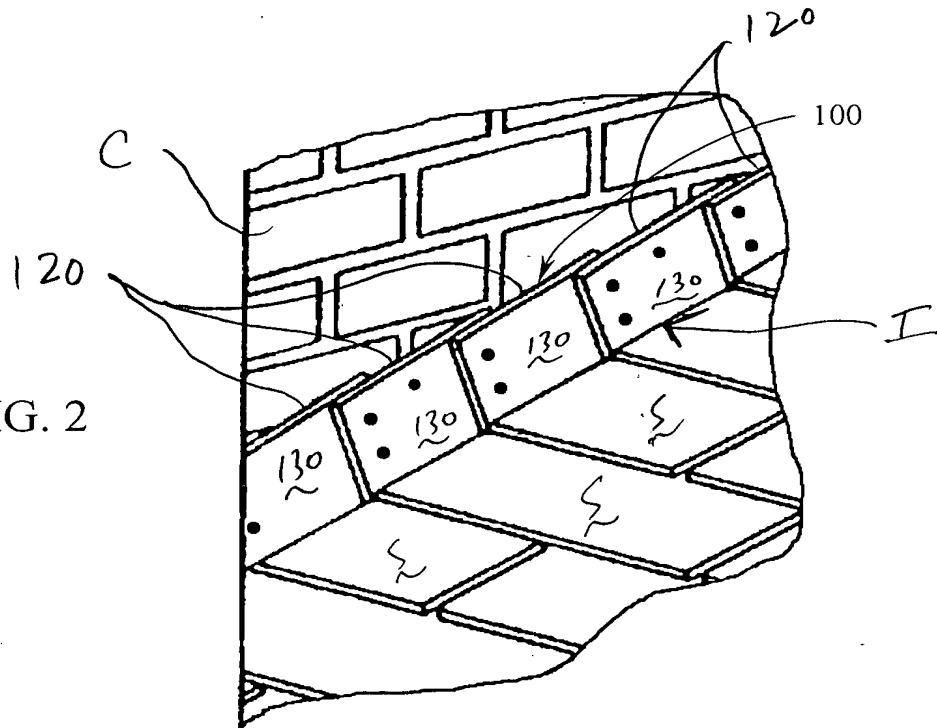


FIG. 2

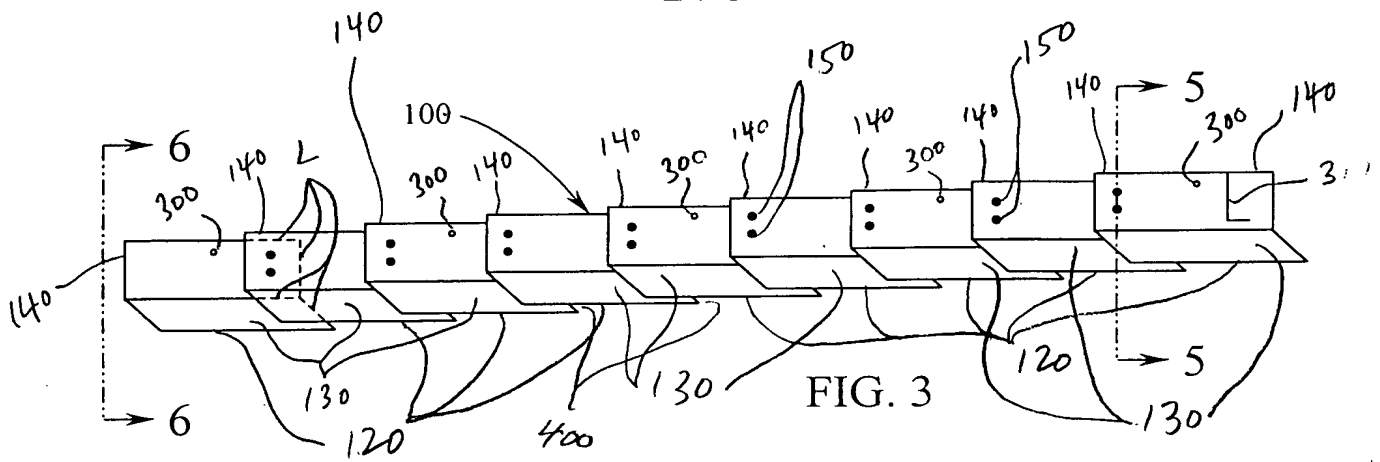


FIG. 3

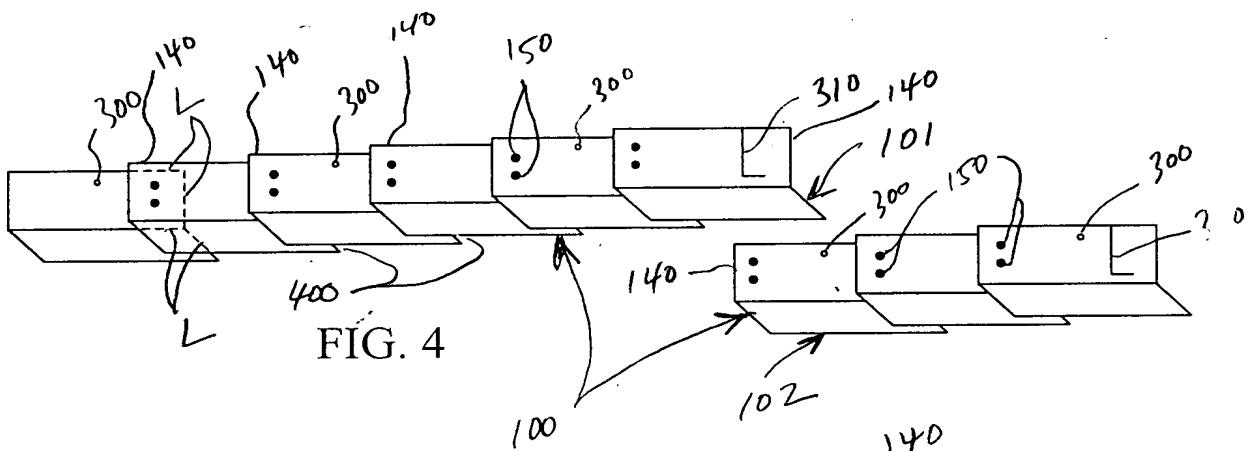


FIG. 4

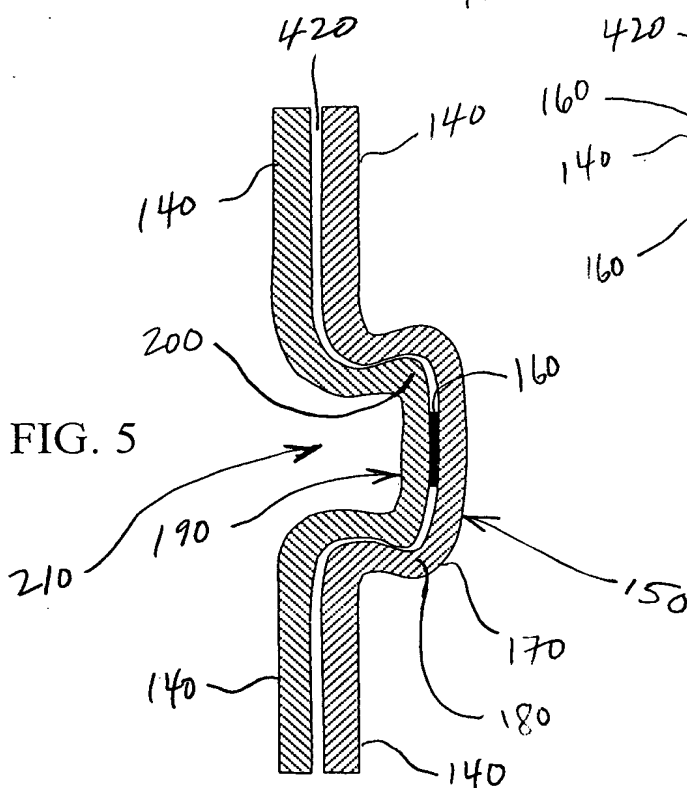


FIG. 5

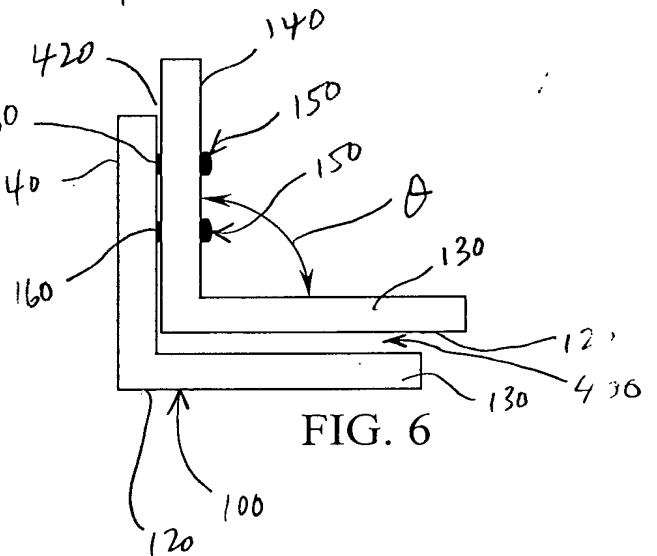


FIG. 6

FIG. 7

FIG. 8

FIG. 8 is a cross-sectional view of a device assembly. A central vertical component 220 is surrounded by a sleeve 240. This assembly is seated within a U-shaped component 200. The entire assembly is mounted on a base 250. A cross-hatched layer 280 is located between the base 250 and the U-shaped component 200. A layer 186 is on the left side of the base 250. A layer 170 is on the right side of the base 250. A layer 140 is on the right side of the U-shaped component 200. A double-headed arrow labeled B indicates a vertical dimension or movement.

A cross-sectional view of a device assembly. It features a base layer 160 with horizontal lines, a middle layer 140 with diagonal hatching, and a top layer 250 with horizontal lines. A central component 220, shown with vertical lines, is positioned on top of layer 140. This component 220 is surrounded by a material 230, which is in turn surrounded by a layer 240. A downward arrow labeled 'C' indicates a direction or force applied to the top of component 220.